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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/827,064	04/19/2004	Cyril Cabral, JR.	YOR919990509US3 (13171AB)	2363	
23389	7590 10/18/2005		EXAM	INER	
SCULLY SCOTT MURPHY & PRESSER, PC 400 GARDEN CITY PLAZA			DOTY, HEAT	DOTY, HEATHER ANNE	
SUITE 300	CITTPLAZA		ART UNIT	PAPER NUMBER	
	ΓY, NY 11530		2813		

DATE MAILED: 10/18/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			EY		
	Application No.	Applicant(s)	<i>L</i>		
	10/827,064	CABRAL, ET AL.	:		
Office Action Summary	Examiner	Art Unit	<del>:</del>		
	Heather A. Doty	2813	;		
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet wi	th the correspondence address			
A SHORTENED STATUTORY PERIOD FOR REP	DIVIS SET TO EXPIRE 3 M	ONTH(S) OR THIRTY (30) DAYS	•		
<ul> <li>WHICHEVER IS LONGER, FROM THE MAILING</li> <li>Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.</li> <li>If NO period for reply is specified above, the maximum statutory perions.</li> <li>Failure to reply within the set or extended period for reply will, by statential.</li> </ul>	DATE OF THIS COMMUNIC 1.136(a). In no event, however, may a rood will apply and will expire SIX (6) MON tute, cause the application to become AB	CATION.  eply be timely filed  THS from the mailing date of this communication.  ANDONED (35 U.S.C. § 133).	:		
Any reply received by the Office later than three months after the ma earned patent term adjustment. See 37 CFR 1.704(b).	liling date of this communication, even if	amely filed, may reduce any	:		
Status		·	:		
1) Responsive to communication(s) filed on 01	August 2005.		;		
•—	his action is non-final.		:		
3) Since this application is in condition for allow	vance except for formal matte	ers, prosecution as to the merits is	.*		
closed in accordance with the practice unde	r <i>Ex par</i> te Quayle, 1935 C.D	. 11, 453 O.G. 213.	:		
Disposition of Claims			•		
·	O a a c Paraga		•		
4) Claim(s) <u>24,25 and 28-32</u> is/are pending in t			:		
4a) Of the above claim(s) is/are withd	rawn from consideration.		:		
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>24,25 and 28-32</u> is/are rejected. 7)□ Claim(s) is/are objected to					
8) Claim(s) are subject to restriction and	d/or election requirement.				
	•		:		
Application Papers		·	•		
9)☐ The specification is objected to by the Exam	iner.		:		
10)⊠ The drawing(s) filed on 19 April 2004 is/are:			<u>.</u>		
Applicant may not request that any objection to t	• • • • • • • • • • • • • • • • • • • •		:		
Replacement drawing sheet(s) including the corr			. :		
11) ☐ The oath or declaration is objected to by the	Examiner. Note the attached	Office Action or form PTO-152.			
Priority under 35 U.S.C. § 119		·	:		
12) Acknowledgment is made of a claim for forei	an priority under 35 U.S.C. §	119(a)-(d) or (f).			
a) ☐ All b) ☐ Some * c) ☐ None of:					
1. Certified copies of the priority docume	ents have been received.		:		
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the p	riority documents have been	received in this National Stage			
application from the International Bure	eau (PCT Rule 17.2(a)).		:		
* See the attached detailed Office action for a l	ist of the certified copies not	received.	:		
			:		
A44-b			•		
Attachment(s)  Notice of References Cited (PTO-892)	4) Intention 9	Summary (PTO-413)			
2) Notice of Praftsperson's Patent Drawing Review (PTO-948)	Paper No(s	s)/Mail Date			
Information Disclosure Statement(s) (PTO-1449 or PTO/SB/	08) 5) Notice of Ir 6) Other:	nformal Patent Application (PTO-152)	•		
Paper No(s)/Mail Date	o) 🗀 Otilei	<del>_</del> ·	:		

#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

Applicant's amendment to claim 32 has overcome the rejection under 35 USC 112, first paragraph, of claims 24, 25, and 28-32 made in the Office Action dated 19 May 2005, as indicated in the Advisory Action dated 15 July 2005.

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 31 and 32 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

A broad range or limitation together with a narrow range or limitation that falls within the broad range or limitation (in the same claim) is considered indefinite, since the resulting claim does not clearly set forth the metes and bounds of the patent protection desired. See MPEP § 2173.05(c). Note the explanation given by the Board of Patent Appeals and Interferences in *Ex parte Wu*, 10 USPQ2d 2031, 2033 (Bd. Pat. App. & Inter. 1989), as to where broad language is followed by "such as" and then narrow language. The Board stated that this can render a claim indefinite by raising a question or doubt as to whether the feature introduced by such language is (a) merely exemplary of the remainder of the claim, and therefore not required, or (b) a required feature of the claims. Note also, for example, the decisions of *Ex parte Steigewald*, 131 USPQ 74 (Bd. App. 1961); *Ex parte Hall*, 83 USPQ 38 (Bd. App. 1948); and *Ex parte Hasche*, 86 USPQ 481 (Bd. App. 1949).

In the present instance, claims 31 and 32 recite the broad recitation "at least one additive selected from the group consisting of C, Al, Se, Ti, V, Cr, Mn, Fe, Co, Y, Zr, Nb, Mo, Ru, Rh, Pd, In, Sn, La, Hf, Ta, W, Re, Ir, Pt, Ce, Pr, Nd, Sm, Eu, Gd, Te, Dy, Ho, Er, Tm, Tb and Lu." Claim 31 also recites "at least one additive is C, Al, Sc, Ti, V, Cr, Mn, Fe, Co, Cu, Y, Zr, nb, Mo, Ru, Rh, Pd, In, Sn, La, Hf, Ta, W, Re, Ir or Pt," which is the narrower statement of the range/limitation. Claim 32 also recites "at least one additive is Ti, V, Cr, Nb, Rh, Ta, Re or Ir," which is the narrower statement of the range/limitation.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 24, 25, and 28-31 are rejected under 35 U.S.C. 103(a) as being unpatentable over Legoues et al. (US 5,810,924), assigned to the same assignee as the instant application, in view Besser et al. (US 6,165,903) and Rosvold (U.S. 3,855,612).

Regarding claim 24, Legoues et al. discloses an electrical contact to a region of a silicon-containing substrate comprising, a substrate having an exposed region of a silicon-containing semiconductor material (paragraph bridging cols. 5-6); and a first layer of Ni silicide, wherein said substrate and said first layer are separated by a Si-Ge interlayer 12 (col. 6, lines 6-24; paragraph bridging cols.14-15).

Legoues et al. does not indicate that the nickel silicide is nickel monosilicide

(NiSi) or that the nickel monosilicide comprises at least one of the claimed additives.

Besser et al. teaches that it is know in the art that NiSi, by contrast to the

disilicides of Ti and Co (TiSi<sub>2</sub> and CoSi<sub>2</sub>), is the low-resistivity phase of nickel silicide

(col. 1, lines 22-30).

It would have been obvious for one of ordinary skill in the art, at the time of the

invention, to use nickel monosilicide as the nickel silicide in Legoues et al. because it is

the low-resistivity phase of the nickel silicide, as taught to be well know in the art by

Besser et al.

Rosvold teaches forming nickel silicide comprising platinum as an additive (52 in

Fig. 6; column 5, lines 24-47) on a silicon substrate (column 3, lines 33-38), to form a

contact with low resistance (column 7, lines 10-12) that operates very effectively with

either gold or aluminum bonding systems (column 7, lines 46-48).

Therefore, at the time of the invention, it would have been obvious to one of

ordinary skill in the art to combine the teachings of Besser et al. and Legoues et al. with

the teachings of Rosvold to add an additive such as platinum to nickel monosilicide to

form an electrical contact. The motivation for doing so at the time of the invention would

have been that such a silicide offers low contact resistance and operates effectively with

either gold or aluminum bonding systems, as expressly taught by Rosvold.

Regarding claim 25, Legoues et al. discloses the electrical contact of claim 24

wherein said silicon-containing semiconductor material comprises, inter alia, single-

crystal Si and SiGe (paragraph bridging cols. 5-6).

Regarding claims 28-30, Legoues et al. discloses a p-i-n diode 25, therefore the substrate necessarily includes a doped p+ and n+ regions. While the nomenclature "+" is not used, the "+" is a relative term of degree and does not have patentable weight absent a specifically claimed amount.

Regarding claim 31, Legoues et al., Besser et al., and Rosvold together teach the electrical contact of claim 24 wherein one additive is Pt (see 35 USC 103(a) rejection of claim 24 above).

Claims 24, 25, and 28-31 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yoshimi et al. (US 5,698,869) in view of Besser et al. (U.S. 6,165,903).

Regarding claim 24, Yoshimi et al. discloses an electrical contact to a region of a silicon- containing substrate comprising, a substrate 201 having an exposed region of a silicon-containing semiconductor material (Fig. 14); and a first layer of Ni silicide 74, wherein said substrate and said first layer are separated by a Si-Ge interlayer 47 (Fig. 14, paragraph bridging cols. 19-20, col. 20, lines 50-60, and col. 21, lines 50-54).

Yoshimi et al. does not indicate that the nickel silicide is nickel monosilicide (NiSi) or that the nickel monosilicide comprises at least one of the claimed additives.

Besser et al. teaches that it is know in the art that NiSi, by contrast to the disilicides of Ti and Co (TiSi<sub>2</sub> and CoSi<sub>2</sub>), is the low-resistivity phase of nickel silicide (col. 1, lines 22-30).

It would have been obvious for one of ordinary skill in the art, at the time of the invention, to use nickel monosilicide as the nickel silicide in Yoshimi et al. because it is

the low-resistivity phase of the nickel silicide, as taught to be well know in the art by Besser et al.

Rosvold teaches forming nickel silicide comprising platinum as an additive (**52** in Fig. 6; column 5, lines 24-47) on a silicon substrate (column 3, lines 33-38), to form a contact with low resistance (column 7, lines 10-12) that operates very effectively with either gold or aluminum bonding systems (column 7, lines 46-48).

Therefore, at the time of the invention, it would have been obvious to one of ordinary skill in the art to combine the teachings of Besser et al. and Yoshimi et al. with the teachings of Rosvold to add an additive such as platinum to nickel monosilicide to form an electrical contact. The motivation for doing so at the time of the invention would have been that such a silicide offers low contact resistance and operates effectively with either gold or aluminum bonding systems, as expressly taught by Rosvold.

Regarding claim 25, Yoshimi et al. discloses the electrical contact of claim 24 wherein said silicon-containing semiconductor material comprises, *inter alia*, silicon-on-insulator (SOI) (col. 19, lines 50-54).

Regarding claims 28-30, Yoshimi et al. discloses the electrical contact of claim 24 wherein said substrate 201 is p-type doped (Fig. 14; col. 19, lines 50-54) and therefore includes p+ doped regions. The substrate also includes n+ regions 206 (Fig. 4A). While the nomenclature "p+" is not used, the "+" is a relative term of degree and does not have patentable weight absent a specifically claimed amount.

Regarding claim 31, Regarding claim 31, Yoshimi et al., Besser et al., and Rosvold together teach the electrical contact of claim 24 wherein one additive is Pt (see 35 USC 103(a) rejection of claim 24 above).

### Response to Arguments

Applicant's arguments dated 01 August 2005 with respect to claims 24, 25, and 28-31 have been considered but are moot in view of the new ground(s) of rejection.

## Allowable Subject Matter

Claim 32 would be allowable if rewritten to overcome the rejection(s) under 35 U.S.C. 112, 2nd paragraph, set forth in this Office action and to include all of the limitations of the base claim and any intervening claims.

The following is a statement of reasons for the indication of allowable subject matter:

Prior art does not teach or suggest, in combination with the other claimed limitations, an electrical contact to a silicon-containing substrate comprising nickel monosilicide, wherein the nickel monosilicide comprises an additive that is Ti, V, Cr, Nb, Rh, Ta, Re, or Ir.

#### Continued Examination Under 37 CFR 1.114

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action

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has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 01

August 2005 has been entered.

Conclusion

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Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Heather A. Doty, whose telephone number is 571-272-

8429. The examiner can normally be reached on M-F, 8:30 - 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Carl Whitehead, Jr., can be reached at 571-272-1702. The fax phone

number for the organization where this application or proceeding is assigned is 571-

273-8300.

Information regarding the status of an application may be obtained from the

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